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Basic Patent (No,Kind,Date): JP 9181392 A2 19970711

PATENT FAMILY:

CHINA (CN)

Patent (No,Kind,Date): CN 1158017 A 19970827

SEMICONDUCTOR DEVICE WITH CLEAVED SURFACE (English)

Patent Assignee: SONY CORP (JP)

Author (Inventor): MORITA ETSUO (JP); KAWAI HIROJI (JP)

Priority (No,Kind,Date): JP 95337192 A 19951225; JP 95343813 A 19951228

Applic (No,Kind,Date): CN 96117948 A 19961225

IPC: * H01S-003/18

CA Abstract No: * 127(09)128499C; 127(12)168820G

Language of Document: Chinese

JAPAN (JP)

Patent (No,Kind,Date): JP 9181392 A2 19970711

MANUFACTURE OF SEMICONDUCTOR LIGHT EMITTING DEVICE (English)

Patent Assignee: SONY CORP

Author (Inventor): MORITA ETSUO; KAWAI HIROHARU

Priority (No,Kind,Date): JP 95337192 A 19951225

Applic (No,Kind,Date): JP 95337192 A 19951225

IPC: * H01S-003/18; H01L-033/00

CA Abstract No: ; 127(09)128499C

Language of Document: Japanese

Patent (No,Kind,Date): JP 9186392 A2 19970715

MANUFACTURE OF SEMICONDUCTOR LASERS (English)

Patent Assignee: SONY CORP

Author (Inventor): MORITA ETSUO; KAWAI HIROHARU

Priority (No,Kind,Date): JP 95343813 A 19951228

Applic (No,Kind,Date): JP 95343813 A 19951228

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UNITED STATES OF AMERICA (US)

Patent (No,Kind,Date): US 5753966 A 19980519

SEMICONDUCTOR DEVICE WITH CLEAVED SURFACE (English)

Patent Assignee: SONY CORP (JP)

Author (Inventor): MORITA ETSUO (JP); KAWAI HIROJI (JP)

Priority (No,Kind,Date): JP 95337192 A 19951225; JP 95343813 A 19951228

Applic (No,Kind,Date): US 772066 A 19961219

National Class: * 257627000; 257094000; 257200000; 257352000; 372044000; 372045000

IPC: * H01L-029/04; H01L-031/036

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Language of Document: English

UNITED STATES OF AMERICA (US)

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US 5753966	P	19951225	US AA	PRIORITY (PATENT)
			JP 95337192 A	19951225
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			JP 95343813 A	19951228
US 5753966	P	19961219	US AE	APPLICATION DATA (PATENT)
			(APPL. DATA (PATENT))	
			US 772066 A	19961219
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			INTEREST	
			SONY CORPORATION 7-35, KITASHINAGAWA 6-CHOME,	
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US 5753966	P	19980519	US A	PATENT

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